



YEA SHIN TECHNOLOGY CO., LTD

YS6912L

N-Channel Enhancement MOSFET

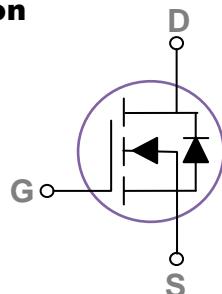
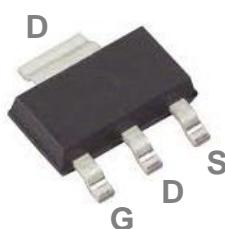
VDS= 60V, ID= 5A



Features

- 60V, 5A, $R_{DS(ON)} = 75m\Omega$ @ $V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

SOT-223 Pin Configuration



Applications

- Motor Drive
- Power Tools
- LED Lighting

Absolute Maximum Rating $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current – Continuous ($T_c=25^\circ C$)	5	A
	Drain Current – Continuous ($T_c=100^\circ C$)	3.2	A
I_{DM}	Drain Current – Pulsed ¹	20	A
EAS	Single Pulse Avalanche Energy ²	25	mJ
IAS	Single Pulse Avalanche Current ²	7	A
P_D	Power Dissipation ($T_c=25^\circ C$)	1.79	W
	Power Dissipation – Derate above $25^\circ C$	0.014	W/ $^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	70	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	30	$^\circ C/W$

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Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	60	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	---	0.05	---	$\text{V}/^\circ\text{C}$
$I_{\text{DS}}^{\text{SS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{\text{DS}}=48\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	---	---	10	μA
$I_{\text{GS}}^{\text{SS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$R_{\text{DS}(\text{ON})}$	Static Drain-source On-Resistance ³	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=5\text{A}$	---	60	75	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=3\text{A}$	---	70	90	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250\mu\text{A}$	1.2	1.8	2.5	V
			---	-5	---	$\text{mV}/^\circ\text{C}$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}, I_{\text{S}}=3\text{A}$	---	7	---	S

Dynamic and Switching Characteristics

Q_g	Total Gate Charge ^{3,4}	$V_{\text{DS}}=48\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=5\text{A}$	---	9.3	14	nC
Q_{gs}	Gate-Source Charge ^{3,4}		---	2.1	4	
Q_{gd}	Gate-Drain Charge ^{3,4}		---	1.8	4	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time ^{3,4}	$V_{\text{DD}}=30\text{V}, V_{\text{GS}}=10\text{V}, R_{\text{G}}=3.3\Omega, I_{\text{D}}=1\text{A}$	---	2.9	6	ns
T_r	Rise Time ^{3,4}		---	9.5	18	
$T_{\text{d}(\text{off})}$	Turn-On Delay Time ^{3,4}		---	18.4	35	
T_f	Fall Time ^{3,4}		---	5.3	10	
C_{iss}	Input Capacitance		---	500	725	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	45	65	
C_{rss}	Reverse Transfer Capacitance		---	16	30	
R_g	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, f=1\text{MHz}$	---	2	4	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	5	A
I_{SM}	Pulsed Source Current ³		---	---	20	A
V_{SD}	Diode Forward Voltage ³	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=1\text{A}, T_J=25^\circ\text{C}$	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{\text{DD}}=25\text{V}, V_{\text{GS}}=10\text{V}, L=1\text{mH}, I_{\text{AS}}=7\text{A}, R_{\text{G}}=25\Omega$, Starting $T_J=25^\circ\text{C}$
3. The data tested by pulsed , pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.

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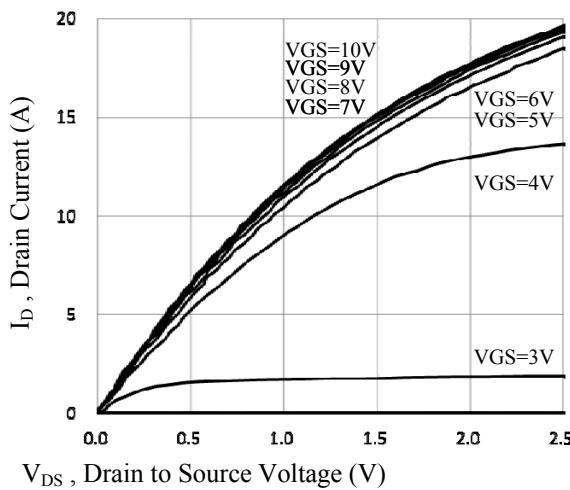


Fig.1 Typical Output Characteristics

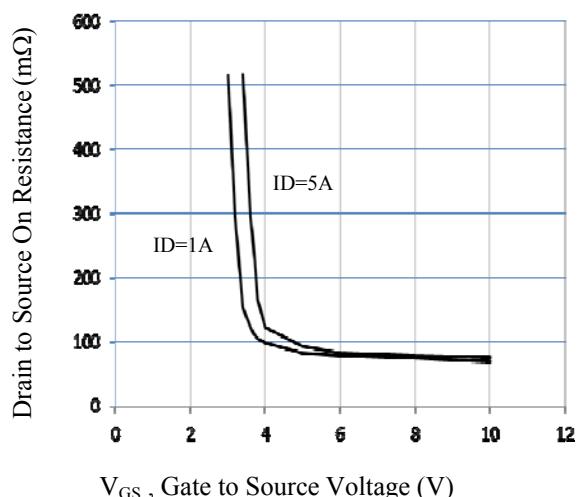


Fig.2 RDSON vs. Gate Voltage

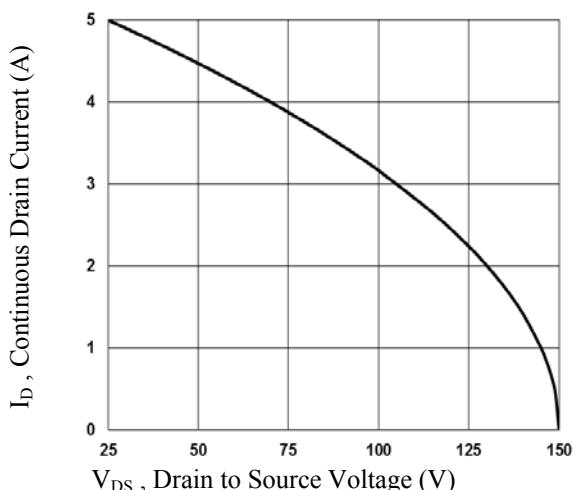


Fig.3 Output Characteristics

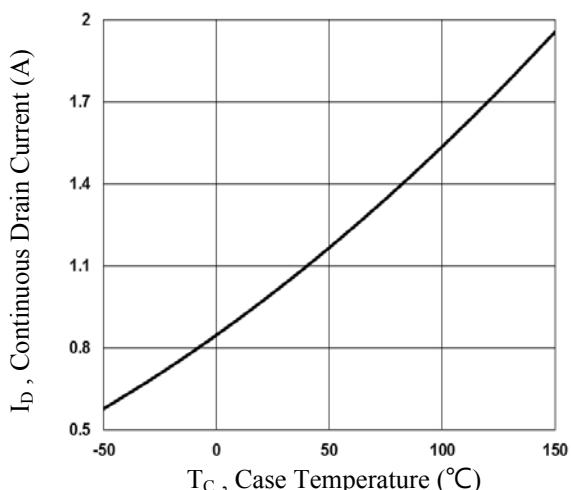


Fig.4 Continuous Drain Current vs. T_c

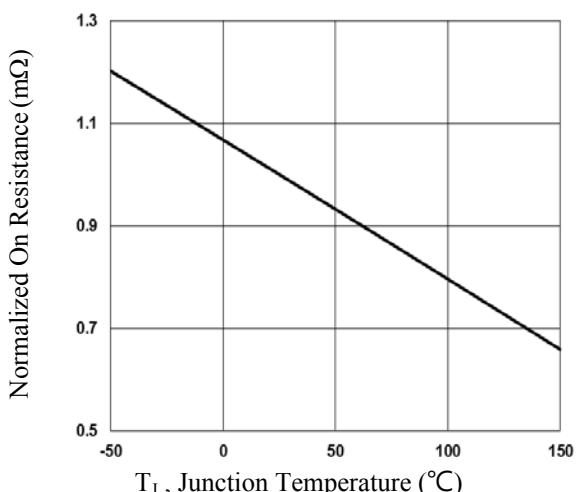


Fig.5 Normalized RDSON vs. T_J

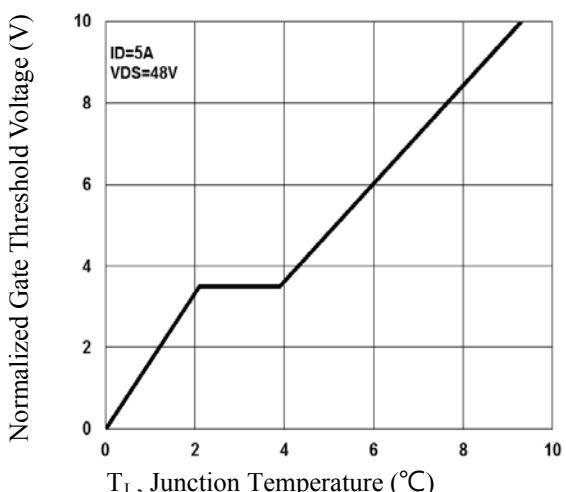


Fig.6 Normalized V_{th} vs. T_J

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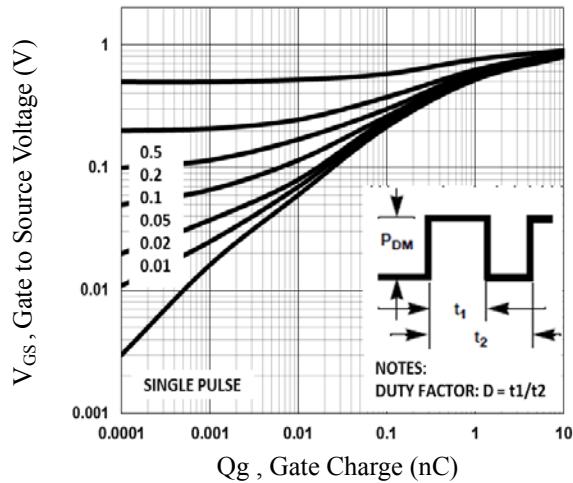


Fig.7 Gate Charge Waveform

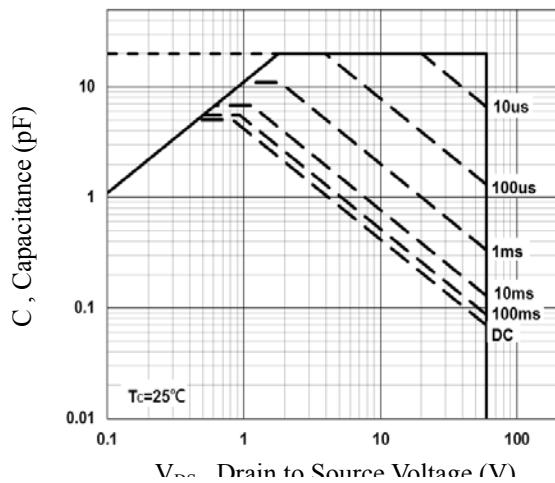


Fig.8 Capacitance Characteristics

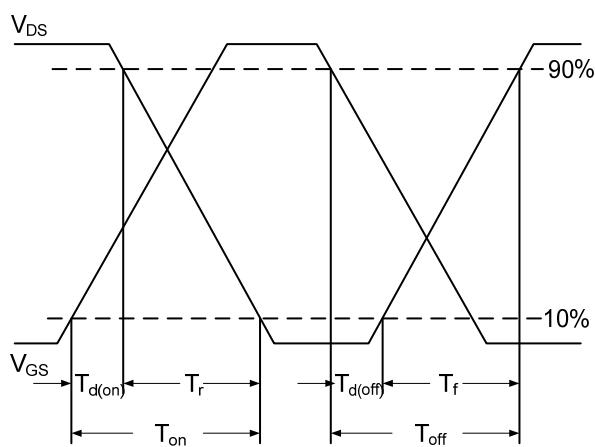


Fig.9 Switching Time Waveform

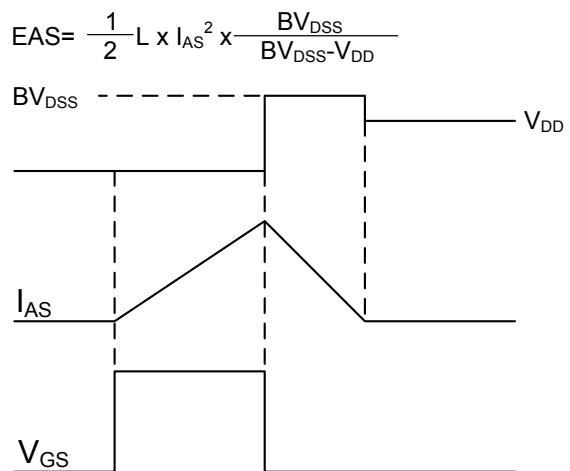
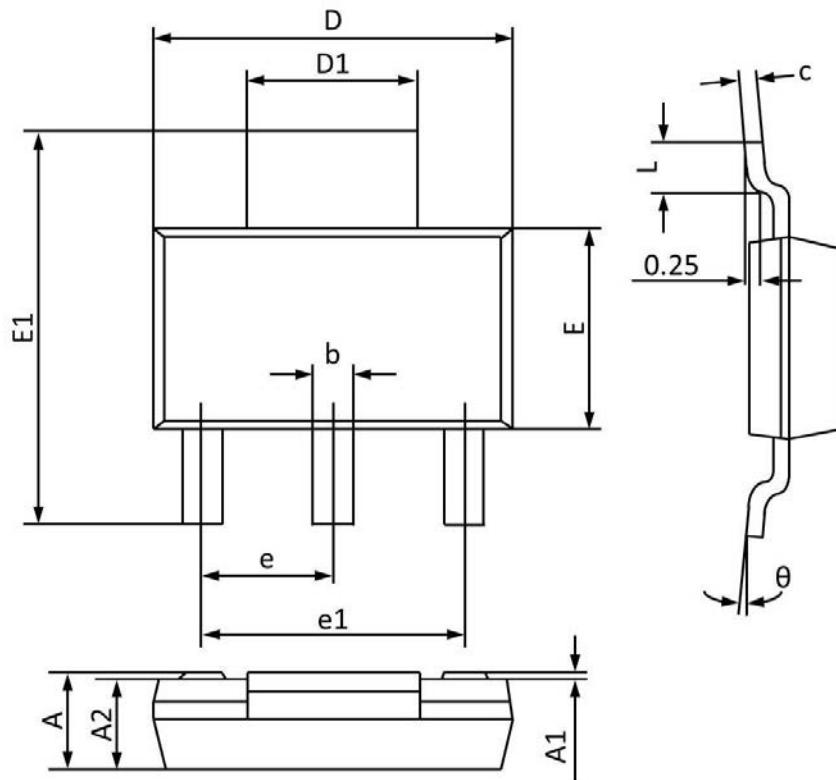


Fig.10 EAS Waveform

PACKAGE OUTLINE & DIMENSIONS

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SOT-223 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.520	1.800	0.060	0.071
A1	0.000	0.100	0.000	0.004
A2	1.500	1.700	0.059	0.067
b	0.660	0.820	0.026	0.032
c	0.250	0.350	0.010	0.014
D	6.200	6.400	0.244	0.252
D1	2.900	3.100	0.114	0.122
E	3.300	3.700	0.130	0.146
E1	6.830	7.070	0.269	0.278
e	2.300 (BSC)		0.091 (BSC)	
e1	4.500	4.700	0.177	0.185
L	0.900	1.150	0.035	0.045
θ	0°	10°	0°	10°